

<b>L Number</b>	<b>Hits</b>	<b>Search Text</b>	<b>DB</b>	<b>Time stamp</b>
<b>1</b>	<b>148</b>	<b>lapping and slider and jig dummy adj section and wafer</b>	<b>USPAT; US-PGPUB; EP ; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 17:14</b>
<b>3</b>	<b>0</b>	<b>lapping and slider and dummy near section and wafer</b>	<b>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 17:15</b>
<b>2</b>	<b>12</b>	<b>lapping and slider and jig and dummy and wafer</b>	<b>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 17:16</b>
<b>-</b>	<b>15</b>	<b>magnetic adj head and supporting near jig</b>	<b>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 17:06</b>
<b>-</b>	<b>1</b>	<b>supporting near jig and wafer and cutting and raw near bars</b>	<b>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 15:50</b>
<b>-</b>	<b>0</b>	<b>20010037555.URPN.</b>	<b>USPAT</b>	<b>2003/06/24 15:49</b>
<b>-</b>	<b>0</b>	<b>20010037555.URPN.</b>	<b>USPAT</b>	<b>2003/06/24 15:50</b>
<b>-</b>	<b>1</b>	<b>supporting near jig and raw near bars</b>	<b>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 15:52</b>
<b>-</b>	<b>3</b>	<b>supporting near jig and raw same bars</b>	<b>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 15:54</b>
<b>-</b>	<b>0</b>	<b>supporting near jig and dummy near section and raw same bars</b>	<b>USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 15:55</b>
<b>-</b>	<b>0</b>	<b>supporting near jig and dummy near secti n and bars</b>	<b>USPAT; US-P PUB; EP ; JPO; DERWENT; IBM_TDB</b>	<b>2003/06/24 15:55</b>

-	0	supp rting near jig and dummy near section	USPAT; US-P PUB; EP ; JP ; DERWENT; IBM_TDB	2003/06/24 15:56
-	9	jig and dummy near secti n	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 15:56
-	1	"6077724".PN.	USPAT	2003/06/24 15:58
-	200	supporting near jig and bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:07
-	8	("4769342"   "5063173"   "5144634"   "5171717"   "5228047"   "5604764"   "5665637"   "5773318").PN.	USPAT	2003/06/24 16:00
-	3	("4731792"   "4879725"   "4901328").PN.	USPAT	2003/06/24 16:04
-	3	supporting near jig and dummy and bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:21
-	3	6332264.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:57
-	1	2000-059307.NRAN.	DERWENT	2003/06/24 16:43
-	0	SHIZAKI near ITOH.inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:45
-	225	Itoh near Hiroyuki .in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:45
-	6	Itoh near Hiroyuki .in. and slider and dummy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:46
-	8	("4536992"   "5020213"   "5095613"   "5329689"   "5406694"   "5463805"   "5603156"   "5718035").PN.	USPAT	2003/06/24 16:48

-	6	("4226018"   "4333229"   "4489484"   "5095613"   "5321882"   "5406694").PN.	USPAT	2003/06/24 16:49
-	8	("4536992"   "5020213"   "5095613"   "5329689"   "5406694"   "5463805"   "5603156"   "5718035").PN.	USPAT	2003/06/24 16:51
-	3	("4536992"   "5020213"   "5095613"   "5329689"   "5406694"   "5463805"   "5603156"   "5718035").PN.) and (29/603; 29/603.16 ; 29/603.2 ; 29/603.15 ; 29/603.14 ; 360/113 ; 360/104 ; 360/105 ; 360/122 ; 360/125).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:58

	<b>Title</b>	<b>Current OR</b>
<b>1</b>	<b>Method of manufacturing thin-film magnetic head</b>	<b>29/603.09</b>
<b>2</b>	<b>Method and apparatus for manufacturing slider</b>	<b>29/729</b>
<b>3</b>	<b>Method of manufacturing slider and slider manufacturing aid</b>	<b>29/737</b>
<b>4</b>	<b>Thin-film magnetic head material and method of manufacturing same and method of manufacturing thin-film magnetic head</b>	<b>438/3</b>
<b>5</b>	<b>Thin-film magnetic head material and method of manufacturing same and method of manufacturing thin-film magnetic head</b>	<b>428/692</b>
<b>6</b>	<b>Method and apparatus for manufacturing slider</b>	<b>29/603.16</b>
<b>7</b>	<b>Method of manufacturing slider and slider manufacturing aid</b>	<b>29/603.12</b>
<b>8</b>	<b>Crown forming method of forming crown on floating type magnetic head</b>	<b>451/28</b>
<b>9</b>	<b>Thin-film magnetic head material and method of manufacturing same and method of manufacturing thin-film magnetic head</b>	<b>428/141</b>
<b>10</b>	<b>Sizing lapping apparatus</b>	<b>451/266</b>

	<b>Title</b>	<b>Current OR</b>
<b>11</b>	<b>Crown forming apparatus for forming crown floating type magnetic head</b>	<b>451/259</b>
<b>12</b>	<b>Lapping apparatus, lapping jig for use therein and workpiece mounting member attached to the lapping jig</b>	<b>451/53</b>